

## Product Summary

V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F</sub> Max (V)	I <sub>R</sub> Max (μA)
50/100/200/ 400/600/800/ 1000	1.0	1.1	10

## Mechanical Data

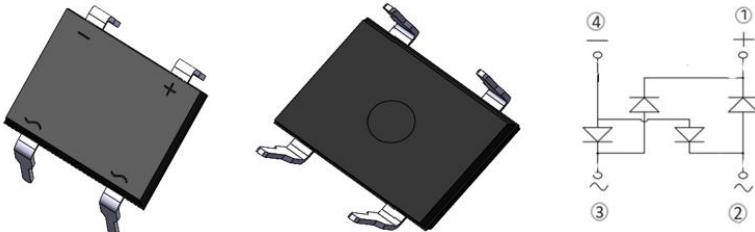
- Package: DF-M
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Finish – Bright Tin. Solder Plated Leads, Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: As Marked on Case
- Weight: 0.38 grams (Approximate)

## Features

- Glass Passivated Die Construction
- Low-Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Printed Circuit Board Applications
- UL Listed under Recognized Component Index, File Number E364304
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.**

<https://www.diodes.com/quality/product-definitions/>

DF-M



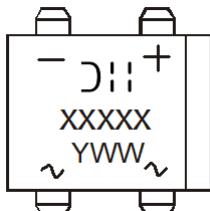
## Ordering Information (Note 3)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
DF005M	DF-M	50	Tube
DF01M	DF-M	50	Tube
DF02M	DF-M	50	Tube
DF04M	DF-M	50	Tube
DF06M	DF-M	50	Tube
DF08M	DF-M	50	Tube
DF10M	DF-M	50	Tube

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



XXXXX = Product Type Marking Code, ex: DF005M

DF = Manufacturer's Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 5 = 2025)

WW = Week Code (01 to 53)

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	DF005M	DF01M	DF02M	DF04M	DF06M	DF08M	DF10M	Unit
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Average Rectified Output Current @ $T_A = +40^\circ\text{C}$	$I_O$				1.0				A
Non-Repetitive Peak Forward Surge Current, 8.3 ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$				50				A
$I^2t$ Rating for Fusing (t < 8.3ms)	$I^2t$				10.4				$\text{A}^2\text{s}$
Operating Temperature Range	$T_J$				-55 to +150				$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$				-55 to +150				$^\circ\text{C}$

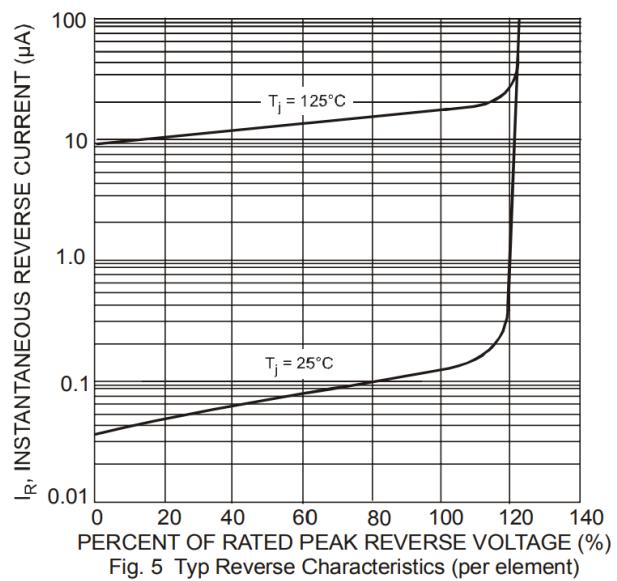
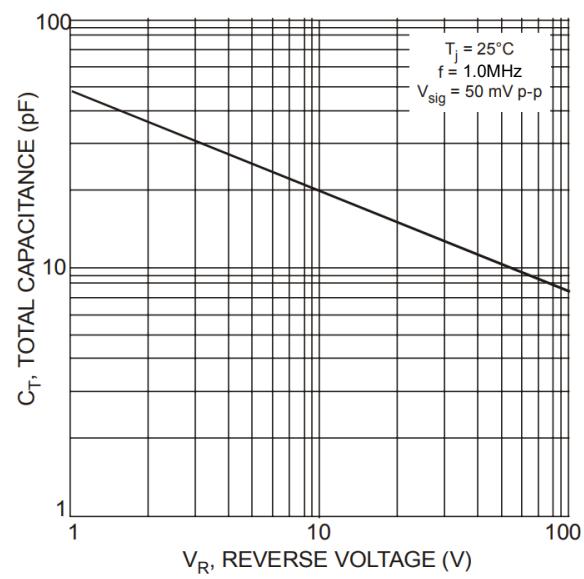
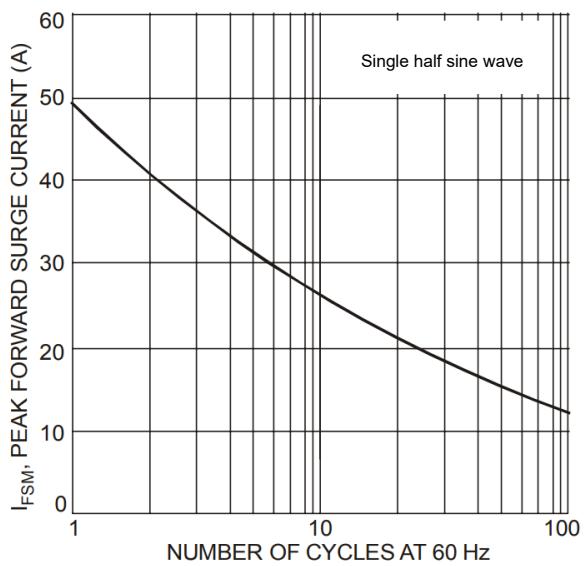
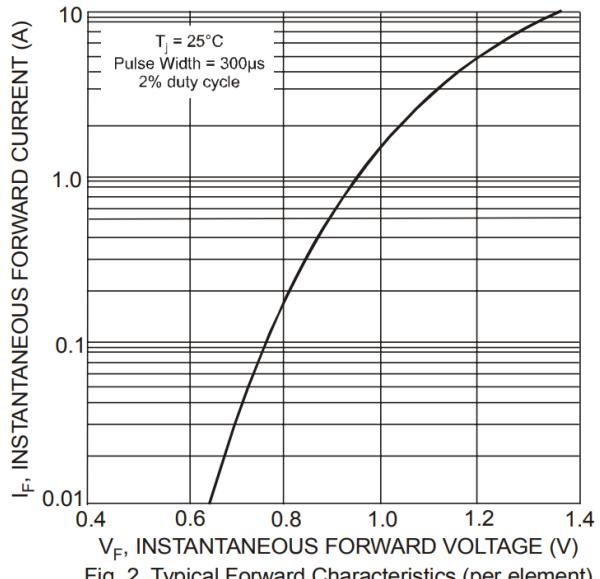
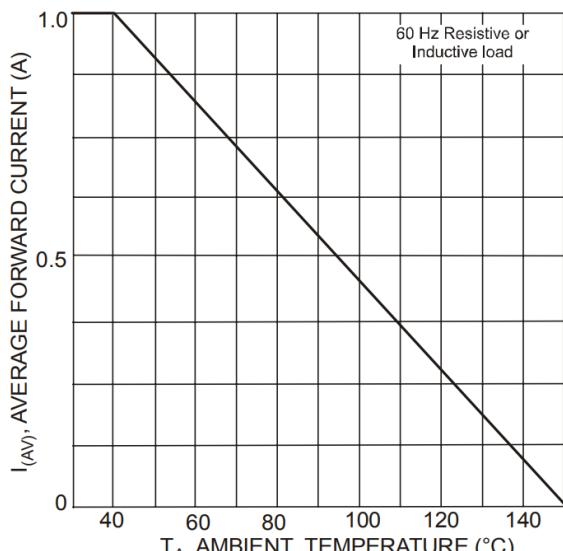
**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Test Conditions		Symbol	Min	Typ	Max	Unit
Breakdown Voltage	$I_R = 10\mu\text{A}$	$T_A = +25^\circ\text{C}$	$V_B$	50/100/200/400 /600/800/1000	—	—	V
Forward Voltage	$I_F = 1.0\text{A}$	$T_A = +25^\circ\text{C}$	$V_F$	—	—	1.1	V
Leakage Current	$V_R$ at Rated	$T_A = +25^\circ\text{C}$ $T_A = +125^\circ\text{C}$	$I_R$	— —	— —	10 500	$\mu\text{A}$
Typical Total Capacitance per Element (Note 4)			$C_T$		25		pF

**Thermal Characteristics**

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Note 5)	$R_{\theta JA}$	40	$^\circ\text{C/W}$

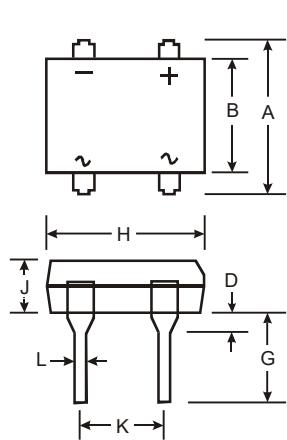
Notes: 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
5. Thermal resistance, junction to ambient, measured on PC board with 5.0mm<sup>2</sup> (0.03mm thick) land areas.



## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

DF-M



DF-M		
Dim	Min	Max
<b>A</b>	7.40	7.90
<b>B</b>	6.20	6.50
<b>C</b>	0.22	0.30
<b>D</b>	1.27	2.03
<b>E</b>	7.60	8.90
<b>G</b>	3.81	4.69
<b>H</b>	8.13	8.51
<b>J</b>	2.40	3.40
<b>K</b>	5.00	5.20
<b>L</b>	0.46	0.58

All Dimensions in mm

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